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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





CURRENT REGULATOR DIODES

Qualified per MIL-PRF-19500/463

*Qualified Levels:
JAN, JANTX, JANTXV
and JANS*

DESCRIPTION

The popular 1N5283-1 thru 1N5314-1 series of 0.5 watt current regulators provides a selection from 0.22 mA to 4.7 mA in standard 10% tolerances. These devices regulate current over a broad voltage range as a counter part offering to Zeners (that regulate voltage over a broad current range) in similar size axial-leaded packages. The somewhat larger DO-7 packaging option offers a double-plug internal bond connection with a larger active die element for its unique function as a current limiter. Microsemi also offers numerous other Zener products to meet higher and lower power voltage regulation applications.

Important: For the latest information, visit our website <http://www.microsemi.com>.

FEATURES

- JEDEC registered 1N5283 thru 1N5314.
- High source impedance.
- Internal metallurgical bond.
- JAN, JANTX, JANTXV, and JANS qualifications are available per MIL-PRF-19500/463.
- Chips also available as JANHC and JANKC.
- RoHS compliant versions available (commercial grade only).

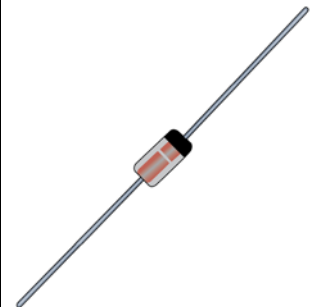
APPLICATIONS / BENEFITS

- Double-plug construction.
- Regulates current over a broad operating voltage and temperature range.
- Extensive selection from 0.22 mA to 4.7 mA.
- Standard current tolerances are plus/minus 10%.
- Flexible axial-lead mounting terminals.
- Non-sensitive to ESD.
- Inherently radiation hard as described in Microsemi "[MicroNote 050](#)".

MAXIMUM RATINGS


Parameters/Test Conditions	Symbol	Value	Unit
Junction and Storage Temperature	T_J and T_{STG}	-65 to +175	°C
Thermal Resistance Junction-to-Lead @ $L = .375$ in	$R_{\theta JL}$	250	°C/W
Thermal Impedance	$Z_{\theta JX}$	25	°C/W
Steady-State Power Dissipation @ $T_L = +50$ °C, $L = 3/8"$ ⁽¹⁾	P_D	500	mW
Working Peak Voltage	V_{WM}	100	V
Solder Pad Temperature @ 10 s max.	T_{SP}	260	°C

Notes: 1. Derate at 4mW/°C above +50°C.



DO-7 Package

Also available in:

 **DO-213AB Package**
(surface mount)
[1N5283UR-1 to 1N5314UR-1](#)

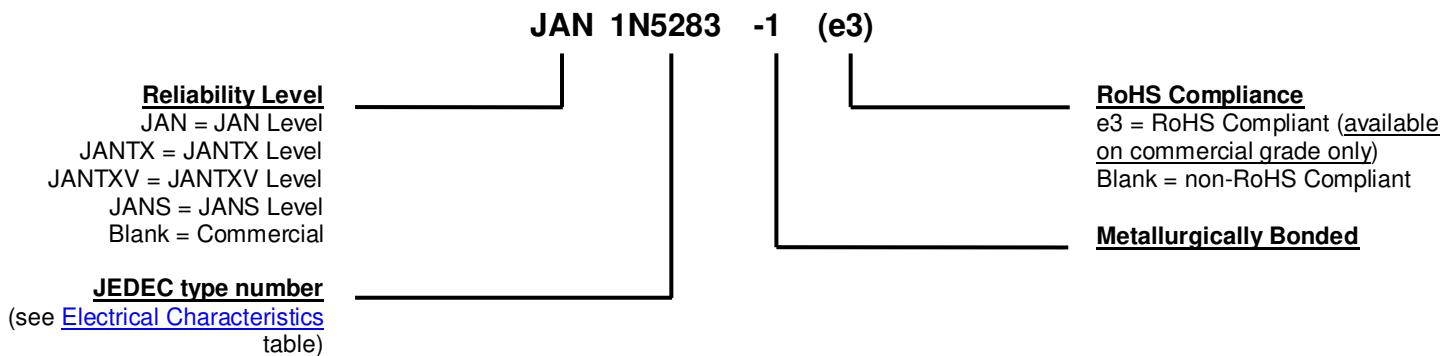
MSC – Lawrence
6 Lake Street,
Lawrence, MA 01841
Tel: 1-800-446-1158 or
(978) 620-2600
Fax: (978) 689-0803

MSC – Ireland
Gort Road Business Park,
Ennis, Co. Clare, Ireland
Tel: +353 (0) 65 6840044
Fax: +353 (0) 65 6822298

Website:
www.microsemi.com

MECHANICAL and PACKAGING

- CASE: Hermetically sealed glass case.
- TERMINALS: Tin/lead finished copper clad steel or RoHS compliant matte-tin finish available (commercial grade only).
- MARKING: Part number and cathode band.
- POLARITY: Diode to be operated with the banded (cathode) end negative.
- TAPE & REEL option: Standard per EIA-296 (add "TR" suffix to part number). Consult factory for quantities.
- WEIGHT: 0.2 grams.
- See [Package Dimensions](#) on last page.

PART NOMENCLATURE

SYMBOLS & DEFINITIONS

Symbol	Definition
I_L	Limiting Current: A specified current below the lower knee of the current-regulating characteristic.
I_S	Regulator current: A current within the regulating range of a current-regulator diode.
P_D	Power Dissipation: The power dissipation, dc.
$R_{\theta JL}$	Thermal Resistance Junction-to-Lead: The thermal resistance from the virtual junction(s) of a semiconductor device to the lead.
T_L	Lead Temperature: The temperature of a lead terminal.
T_{SP}	Temperature Solder Pad: The maximum solder temperature that can be safely applied to the terminal.
V_K	Knee Voltage: A specified regulator voltage near the lower knee of the current-regulating characteristic.
V_L	Limiting Voltage: The voltage at point I_L on the current-voltage characteristic.
V_S	Regulator Voltage: A voltage within the regulating range of a current-regulating diode.
Z_K	Knee Impedance: The small-signal impedance at operating point V_K on the current-voltage characteristic.
Z_S	Regulator Impedance: The small-signal impedance within the regulating range of a current-regulator diode.
$Z_{\theta JX}$	Thermal Impedance: The thermal impedance junction to reference point.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

TYPE NUMBER	REGULATOR CURRENT I_S (mA) @ $V_S = 25\text{ V}$			MINIMUM DYNAMIC IMPEDANCE @ $V_S = 25\text{ V}$ z_s (M Ω) (Note 1)	MINIMUM KNEE IMPEDANCE @ $V_K = 6.0\text{ V}$ z_k (M Ω) (Note 2)	MAXIMUM LIMITING VOLTAGE @ $I_L = 0.8 I_S$ (min) V_L (Volts)
	NOM	MIN	MAX			
1N5283	0.22	0.198	0.242	25.00	2.750	1.00
1N5284	0.24	0.216	0.264	19.00	2.350	1.00
1N5285	0.27	0.243	0.297	14.00	1.950	1.00
1N5286	0.30	0.270	0.330	9.000	1.600	1.00
1N5287	0.33	0.297	0.363	6.600	1.350	1.00
1N5288	0.39	0.351	0.429	4.100	1.000	1.05
1N5289	0.43	0.387	0.473	3.300	0.870	1.05
1N5290	0.47	0.423	0.517	2.700	0.750	1.05
1N5291	0.56	0.504	0.616	1.900	0.560	1.10
1N5292	0.62	0.558	0.682	1.550	0.470	1.13
1N5293	0.68	0.612	0.748	1.350	0.400	1.15
1N5294	0.75	0.675	0.825	1.150	0.335	1.20
1N5295	0.82	0.738	0.902	1.000	0.290	1.25
1N5296	0.91	0.819	1.001	0.880	0.240	1.29
1N5297	1.00	0.900	1.100	0.800	0.205	1.35
1N5298	1.10	0.990	1.210	0.700	0.180	1.40
1N5299	1.20	1.080	1.320	0.640	0.155	1.45
1N5300	1.30	1.170	1.430	0.580	0.135	1.50
1N5301	1.40	1.260	1.540	0.540	0.115	1.55
1N5302	1.50	1.350	1.650	0.510	0.105	1.60
1N5303	1.60	1.440	1.760	0.475	0.092	1.65
1N5304	1.80	1.620	1.980	0.420	0.074	1.75
1N5305	2.00	1.800	2.200	0.395	0.061	1.85
1N5306	2.20	1.980	2.420	0.370	0.052	1.95
1N5307	2.40	2.160	2.640	0.345	0.044	2.00
1N5308	2.70	2.430	2.970	0.320	0.035	2.15
1N5309	3.00	2.700	3.300	0.300	0.029	2.25
1N5310	3.30	2.970	3.630	0.280	0.024	2.35
1N5311	3.60	3.240	3.960	0.265	0.020	2.50
1N5312	3.90	3.510	4.290	0.255	0.017	2.60
1N5313	4.30	3.870	4.730	0.245	0.014	2.75
1N5314	4.70	4.230	5.170	0.235	0.012	2.90

NOTE 1: z_s is derived by superimposing a 90 Hz RMS signal equal to 10% of V_S on V_S .

NOTE 2: z_k is derived by superimposing a 90 Hz RMS signal equal to 10% of V_K on V_K .

GRAPHS

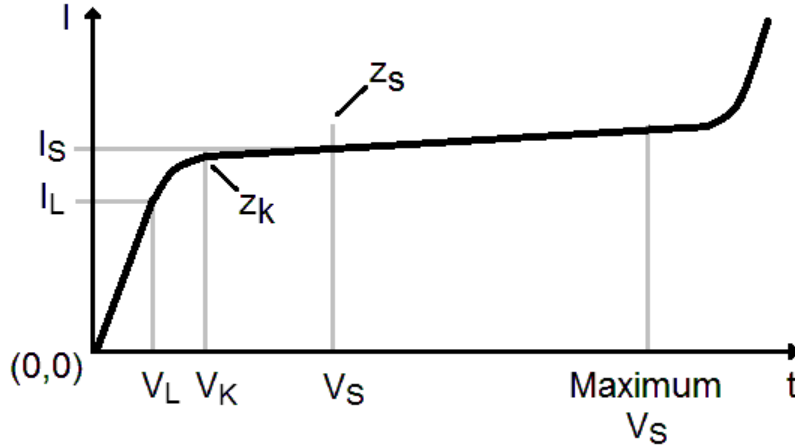


FIGURE 1 – CURRENT-REGULATOR CHARACTERISTICS

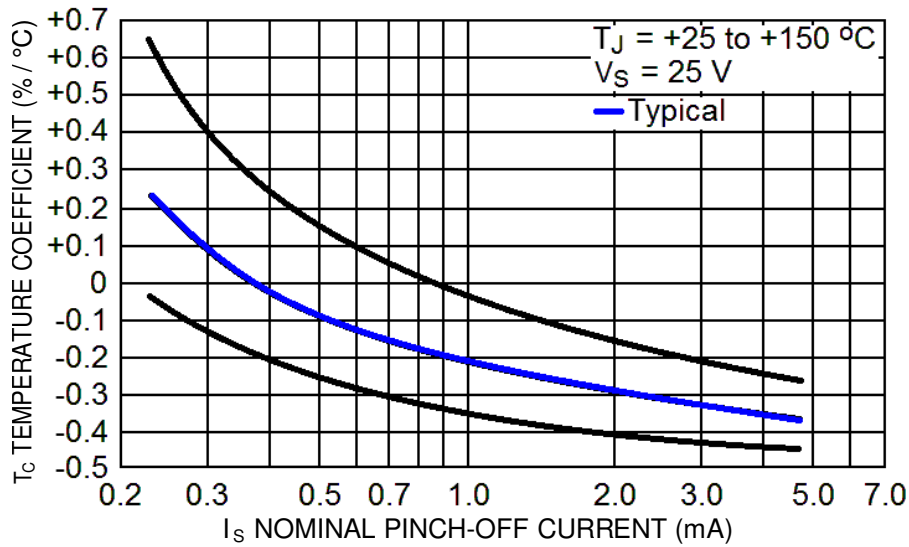


FIGURE 2 – TEMPERATURE COEFFICIENT

GRAPHS (continued)

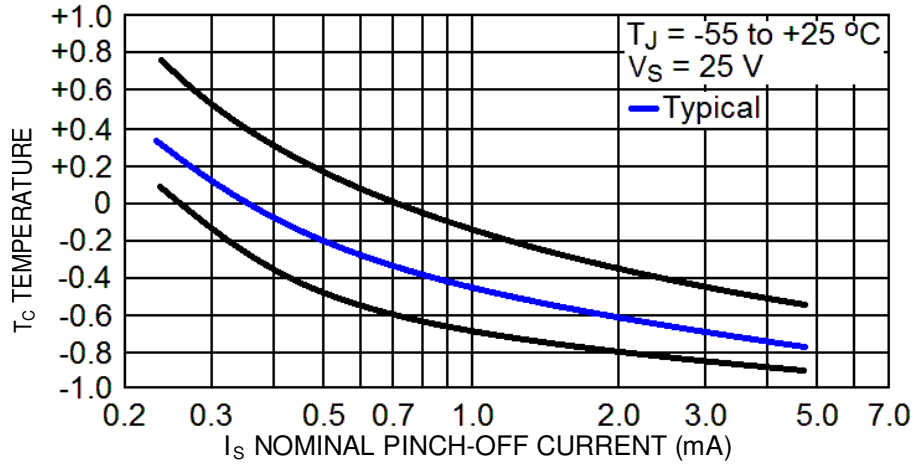


FIGURE 3 – TEMPERATURE COEFFICIENT

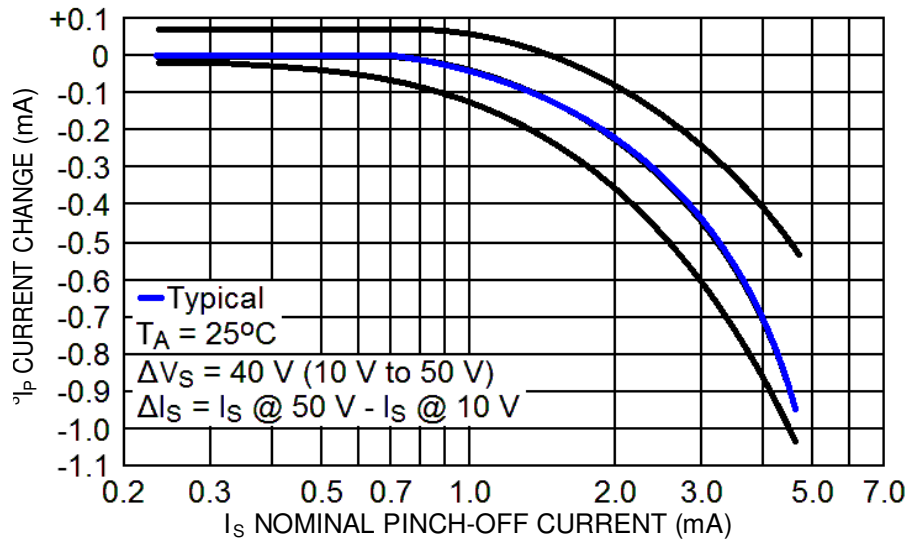
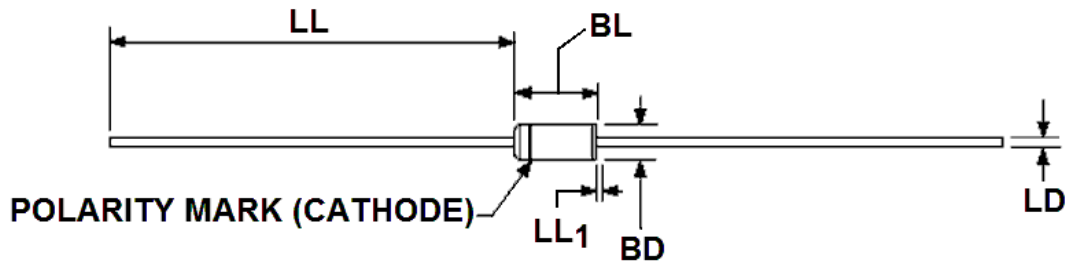


FIGURE 4 – CURRENT REGULATION FACTOR

PACKAGE DIMENSIONS


Symbol	Dimensions			
	Inch		Millimeters	
	Min	Max	Min	Max
BD	.060	.107	1.52	2.72
BL	.120	.300	3.05	7.62
LD	.018	.023	0.46	0.58
LL	1.000	1.500	25.40	38.10
LL₁		0.050		1.27

NOTES:

1. Dimensions are in inches.
2. Millimeters are given for general information only.
3. The minimum body diameter shall be maintained over .15 inch (3.81 mm) inch of body length.
4. The specified lead diameter applies in the zone between .050 inch (1.27 mm) and the end of the lead. Outside of this zone the lead diameter shall not exceed LD.
5. Both leads shall be within the specified dimension.
6. See 3.3 for L and T_L definitions.
7. In accordance with ASME Y14.5M, diameters are equivalent to Φ x symbology.